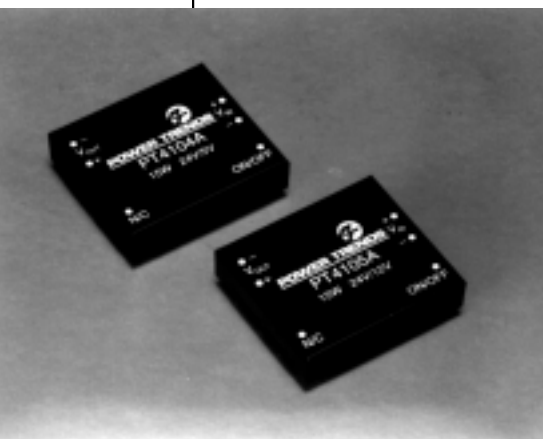
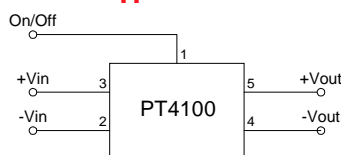


PT4100 Series**24V****15 WATT 24V TO 5V/12V/15V
ISOLATED DC-DC CONVERTER****Revised 5/15/98**

- -40°C to +85°C Operating Temperature Range
- 1500 VDC Isolation
- Power Density 15 Watts/in³
- Wide Input Voltage Range 18V to 40V
- 83% Efficiency
- Small Footprint
- UL Approved

Power Trends' PT4104A (5V), PT4105A (12V) and PT4106A (15V). Isolated DC-DC Converters advance the state-of-the-art for board-mounted converters by employing high switching frequencies greater than 650 KHz and planar magnetics and surface-mount construction. They feature the industry's smallest footprint, a power density of 15 Watts/in³, and operate at 83% efficiency. They are designed for Telecom, Industrial, Computer, Medical, and other distributed power applications requiring input-to-output isolation and an industrial temperature range.

Standard Application**Specifications**

Characteristics (T _a =25°C unless noted)	Symbols	Conditions	PT4100 SERIES				Units
			Min	Typ	Max		
Output Current	I _o	Over V _{in} range, V _o = 5V V _o = 12V V _o = 15V	0 0 0	— — —	3.0 1.25 1.0		A
Current Limit	I _{cl}	V _{in} = 18V, V _o = 5V V _o = 12V V _o = 15V	— — —	4.0 1.75 1.4	— — —		A
On/Off Standby Current	I _{in standby}	V _{in} = 24V, Pin 1 = -V _{in}	—	7	10		mA
Short Circuit Current	I _{sc}	V _{in} = 24V, V _o = 5V V _o = 12V V _o = 15V	— — —	6.25 2.5 2.0	— — —		A
Inrush Current	I _{ir} t _{ir}	V _{in} = 24V @ max I _o On start-up	— —	1.0 1.0	2.0 5.0		A mSec
Input Voltage Range	V _{in}	I _o = 0.1 to max I _o	18.0	24.0	40.0		V
Output Voltage Tolerance	ΔV _o	Over V _{in} Range T _A = -40°C to +85°C	—	±1.0	±2.0		% V _o
Ripple Rejection	RR	Over V _{in} range @ 120 Hz	—	60	—		dB
Line Regulation	Reg _{line}	Over V _{in} range @ max I _o	—	±0.2	±1.0		% V _o
Load Regulation	Reg _{load}	10% to 100% of I _o max	—	±0.4	±1.0		% V _o
V _o Ripple/Noise	V _n	V _{in} =24V, I _o =3.0A, V _o =5V V _{in} =24V, I _o =1.25A, V _o =12V V _{in} =24V, I _o =1.25A, V _o =15V	— — —	75 75 100	100 150 200		mV _{pp} mV _{pp} mV _{pp}
Transient Response	t _{tr}	50% load change V _o over/undershoot	— —	125 3.0	200 5.0		μSec % V _o
Efficiency	η	V _{in} =24V, I _o =3.0A, V _o =5V V _{in} =24V, I _o =1.25A, V _o =12V V _{in} =24V, I _o =1A, V _o =15V	— — —	82 82 83	— — —		% % %
Switching Frequency	f _o	Over V _{in} and I _o , V _o =5V V _o =12V/15V	800 600	850 650	900 700		kHz kHz
Recommended Operating Temperature Range	T _a	V _{in} = 24V @ max I _o Free air convection, (40-60LFM)	-40	—	+85*		°C
Thermal Resistance	θ _{ja}	Free air convection, (40-60LFM)	—	12	—		°C/W
Case Temperature	T _c	@ Thermal shutdown	—	—	100		°C
Storage Temperature	T _s		-40	—	110		°C
Mechanical Shock	—	Per Mil-STD-202F, Method 213B, 6mS, Half-sine, mounted to a PCB	—	50	—		G's
Mechanical Vibration	—	Per Mil-STD-202F, Method 204D, 10-500Hz, Soldered in a PCB	—	10	—		G's
Weight	—		—	28	—		grams
Isolation Capacitance	—		1500	—	—		V
Resistance	—		10	1100	—		pF MΩ
Flammability	—	Materials meet UL 94V-0					
Remote On/Off	On Off	Open or 2.5 to 7.0 VDC above -V _{in} Short or 0 to 0.8 VDC above -V _{in}					

* See Thermal Derating Curves

Pin-Out Information

Pin	Function
1	Remote ON/OFF
2	-V _{in}
3	+V _{in}
4	-V _{out}
5	+V _{out}
6	Do not connect

Ordering Information*Through-Hole*

PT4104A = 5 Volts
PT4105A = 12 Volts
PT4106A = 15 Volts

Surface Mount

PT4104C = 5 Volts
PT4105C = 12 Volts
PT4106C = 15 Volts

(For dimensions and PC board layout, see Package Style 700.)

CHARACTERISTIC DATA

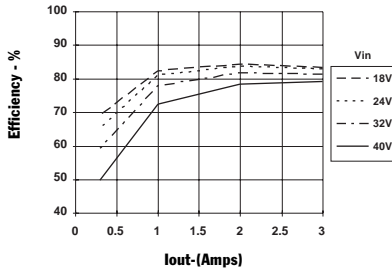
PT4100 Series

24V

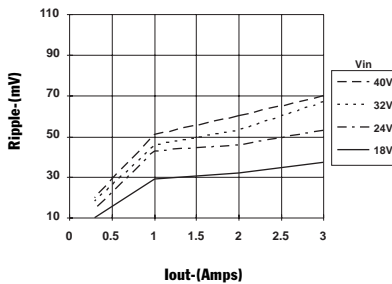
PT4104, 5.0 VDC

(See Note 1)

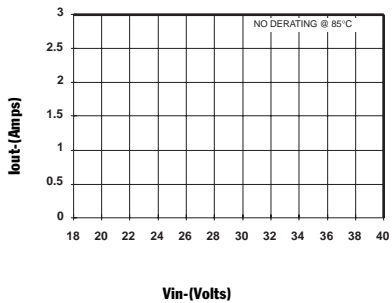
Efficiency vs Output Current



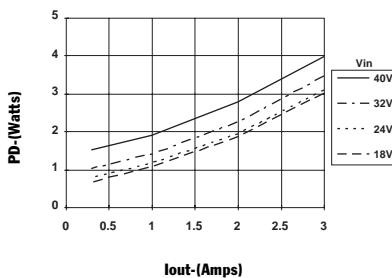
Ripple vs Output Current

Thermal Derating (T_a)

(See Note 2)



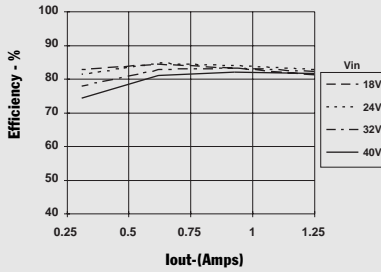
Power Dissipation vs Output Current



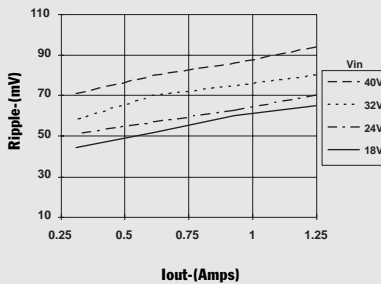
PT4105, 12.0 VDC

(See Note 1)

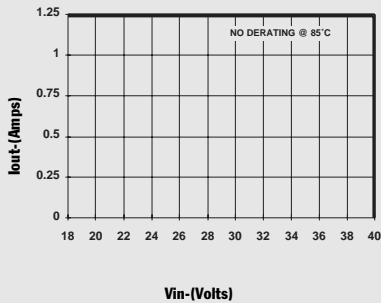
Efficiency vs Output Current



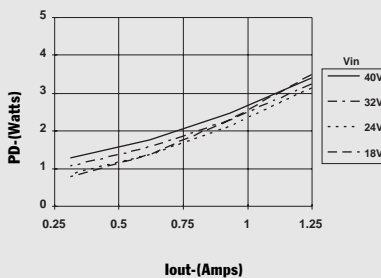
Ripple vs Output Current

Thermal Derating (T_a)

(See Note 2)



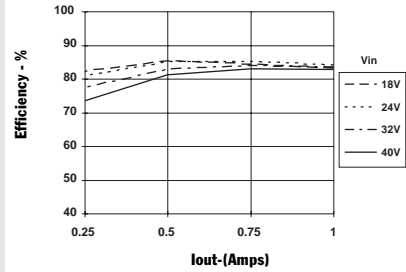
Power Dissipation vs Output Current



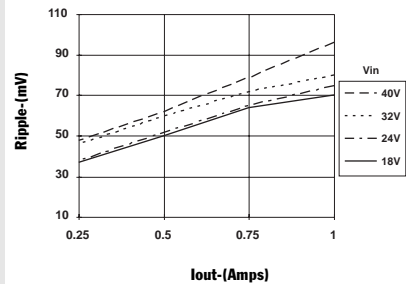
PT4106, 15.0 VDC

(See Note 1)

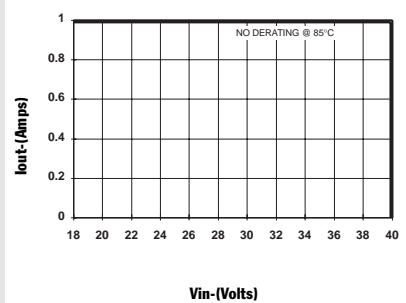
Efficiency vs Output Current



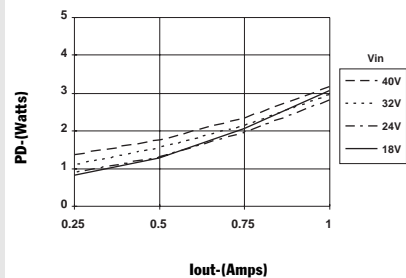
Ripple vs Output Current

Thermal Derating (T_a)

(See Note 2)



Power Dissipation vs Output Current



Note 1: All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the DC-DC Converter.

Note 2: Thermal derating graphs are developed in free air convection cooling of 40-60 LFM.

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